SiHP33N60E

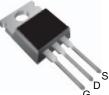
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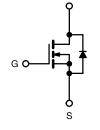


E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.099		
Q _g max. (nC)	150			
Q _{gs} (nC)	24			
Q _{gd} (nC)	42			
Configuration	Single			

TO-220AB





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM): Ron x Qq
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	SiHP33N60E-E3		
Lead (Pb)-free and Halogen-free	SiHP33N60E-GE3		

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	600	v
Gate-Source Voltage			V _{GS}	± 30	v
Continuous Drain Current (T 150 °C)	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	33	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 100 °C		21	А
Pulsed Drain Current ^a			I _{DM}	88	
Linear Derating Factor				2.2	W/°C
Single Pulse Avalanche Energy ^b			E _{AS}	793	mJ
Maximum Power Dissipation			PD	278	W
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope $V_{DS} = 0 V \text{ to } 80 \% V_{DS}$			dV/dt	70	V/ns
Reverse Diode dV/dt ^d				12	v/ns
Soldering Recommendations (Peak temperature) c for 10 s				300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7.5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D,\,dI/dt$ = 100 A/µs, starting T_J = 25 °C.

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COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.45	C/VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} :	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Cata Sauraa Laakaga			$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zava Cata Vialtaga Dirain Current	1	V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 16.5 A	-	0.083	0.099	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} :	= 30 V, I _D = 16.5 A	-	11	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	3508	-	-
Output Capacitance	C _{oss}		V _{DS} = 100 V,	-	156	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	$V_{GS} = 0 V, V_{DS} = 0 V to 480 V$		-	136	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	468	-	
Total Gate Charge	Qq			-	100	150	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V I _D = 16.5 A, V _{DS} = 480 V		-	24	-	nC
Gate-Drain Charge	Q _{gd}			-	42	-	1
Turn-On Delay Time	t _{d(on)}	V _{DD} = 480 V, I _D = 16.5 A		-	28	56	
Rise Time	t _r			-	60	90	- ns
Turn-Off Delay Time	t _{d(off)}	$R_g =$	$R_g = 9.1 \Omega, V_{GS} = 10 V$		99	150	
Fall Time	t _f			-	54	80	1
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.2	0.7	1.0	Ω
Drain-Source Body Diode Characteristic	s	•			•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	33	
Pulsed Diode Forward Current	I _{SM}			-	-	88	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 16.5 A, V _{GS} = 0 V		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	$T_{J} = 25 \text{ °C, } I_{F} = I_{S},$ dl/dt = 100 A/ μ s, V _R = 20 V		-	503	1006	ns
Reverse Recovery Charge	Q _{rr}			-	8.5	17	μC
Reverse Recovery Current	I _{RRM}			-	26	-	A

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

c. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

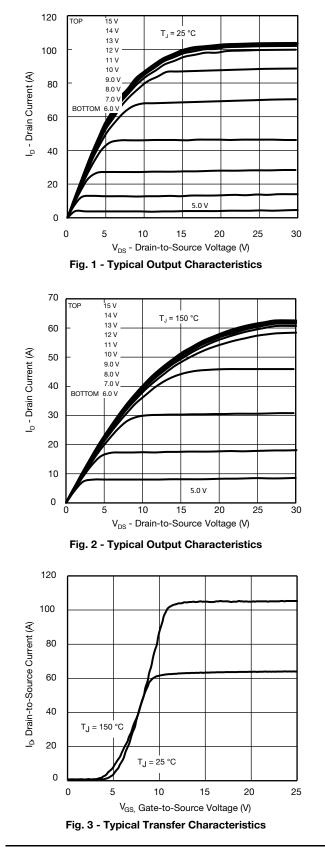
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SiHP33N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



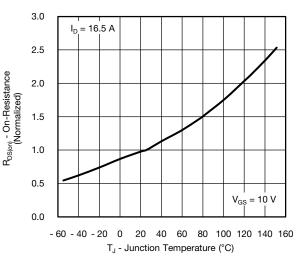


Fig. 4 - Normalized On-Resistance vs. Temperature

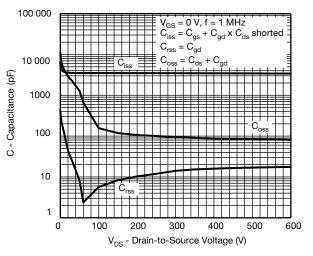
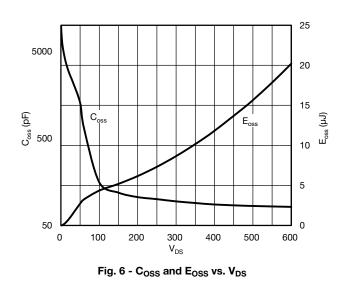


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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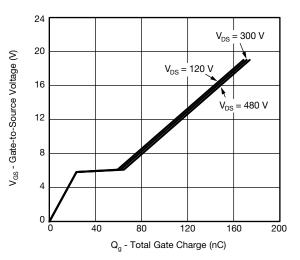


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

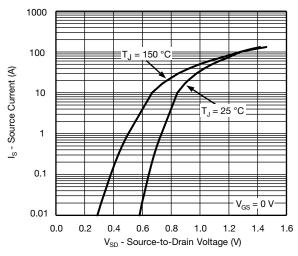


Fig. 8 - Typical Source-Drain Diode Forward Voltage

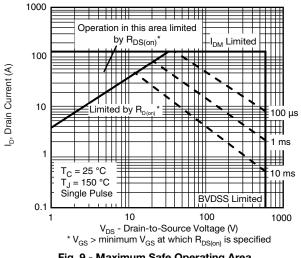


Fig. 9 - Maximum Safe Operating Area

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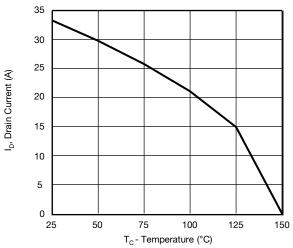


Fig. 10 - Maximum Drain Current vs. Case Temperature

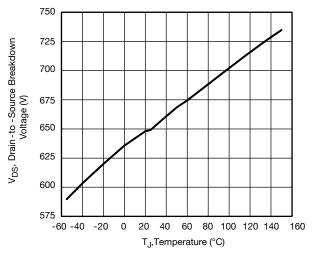


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature

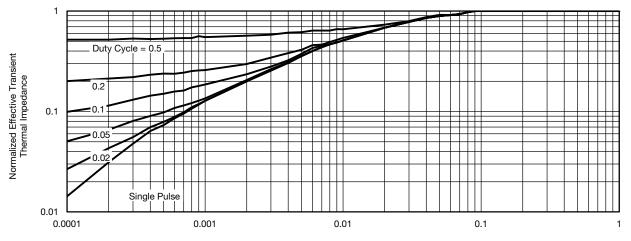
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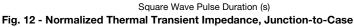
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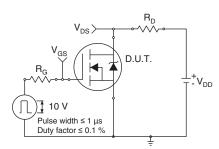


Fig. 13 - Switching Time Test Circuit

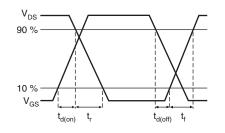


Fig. 14 - Switching Time Waveforms

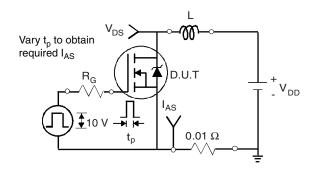


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

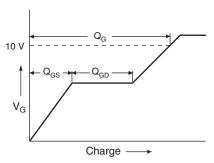
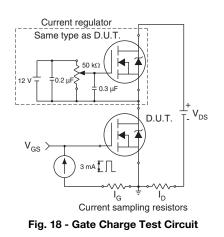


Fig. 17 - Basic Gate Charge Waveform





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Peak Diode Recovery dV/dt Test Circuit

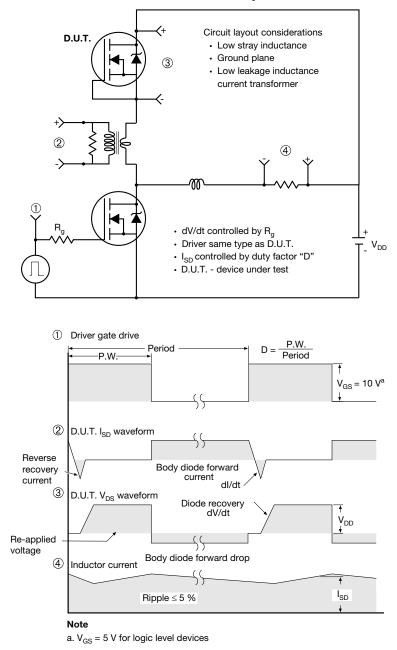


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi	'an		
		IRF 9510 744K AB			

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